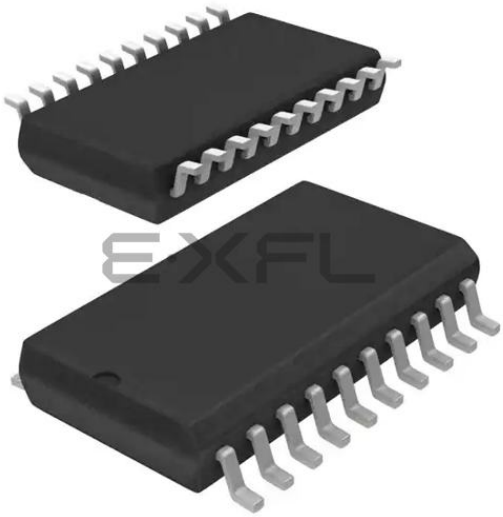


Welcome to E-XFL.COM

Understanding Embedded - PLDs (Programmable Logic Devices)

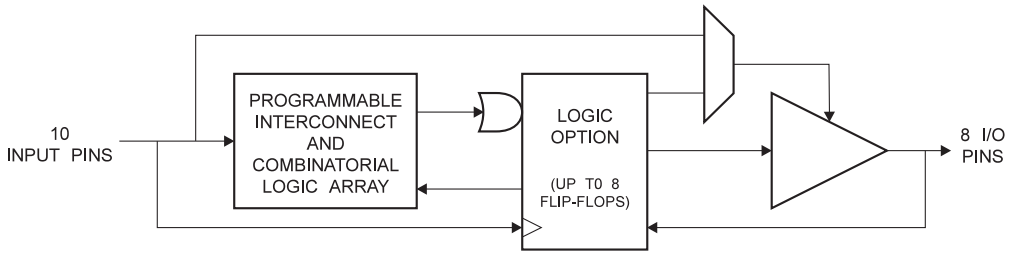
Embedded - PLDs, or Programmable Logic Devices, are a type of digital electronic component used to build reconfigurable digital circuits. Unlike fixed-function logic devices, PLDs can be programmed to perform specific functions by the user. This flexibility allows designers to customize the logic to meet the exact needs of their applications, making PLDs a crucial component in modern embedded systems.

Applications of Embedded - PLDs (Programmable Logic Devices)

The versatility of PLDs makes them suitable for a wide range of applications. In consumer electronics, PLDs are used to enhance the functionality and performance of

Details	
Product Status	Obsolete
Programmable Type	EE PLD
Number of Macrocells	8
Voltage - Input	5V
Speed	12 ns
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atf16v8cz-12sc

Figure 1-1. Block Diagram



2. Pin Configuration and Pinouts

Table 2-1. Pinouts - All Pinouts Top View

Pin Name	Function
CLK	Clock
I	Logic Inputs
I/O	Bi-directional Buffers
$\overline{OE}$	Output Enable
VCC	+5V Supply

Figure 2-1. TSSOP

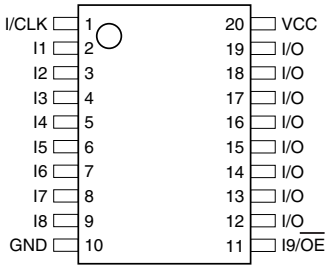


Figure 2-2. DIP/SOIC

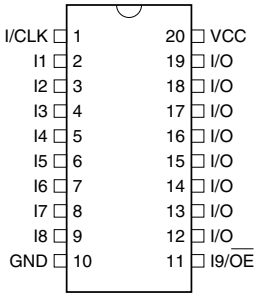
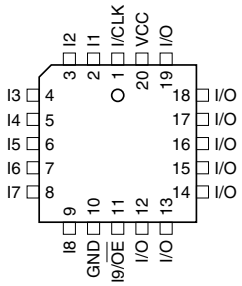


Figure 2-3. PLCC



3. Absolute Maximum Ratings*

Temperature Under Bias	-40°C to +85°C
Storage Temperature	-65°C to +150°C
Voltage on Any Pin with Respect to Ground	-2.0V to +7.0V[1]
Voltage on Input Pins with Respect to Ground During Programming	-2.0V to +14.0V[1]
Programming Voltage with Respect to Ground	-2.0V to +14.0V[1]

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC, which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is V_{CC} + 0.75V DC, which may overshoot to 7.0V for pulses of less than 20 ns.

4. DC and AC Operating Conditions

	Commercial	Industrial
Operating Temperature (Ambient)	0°C - 70°C	-40°C - 85°C
V_{CC} Power Supply	5V ±5%	5V ±10%

4.1 DC Characteristics

Symbol	Parameter	Condition		Min	Typ	Max	Units
I_{IL}	Input or I/O Low Leakage Current	$0 \le V_{IN} \le V_{IL}$(Max)				-10	µA
I_{IH}	Input or I/O High Leakage Current	$3.5 \le V_{IN} \le V_{CC}$				10	µA
I_{CC1}	Power Supply Current	15 MHz, V_{CC} = Max, V_{IN} = 0, V_{CC}, Outputs Open	Com			95	mA
			Ind.			105	mA
I_{CC}[1]	Power Supply Current, Standby Mode	0 MHz, V_{CC} = Max, V_{IN} = 0, V_{CC}, Outputs Open	Com.		5		µA
			Ind		5		µA
I_{OS}	Output Short Circuit Current	V_{OUT} = 0.5V; V_{CC}= 5V; TA = 25°C				-150	mA
V_{IL}	Input Low Voltage	Min < V_{CC} < Max		-0.5		0.8	V
V_{IH}	Input High Voltage			2.0		V_{CC}+1	V
V_{OL}	Output Low Voltage	V_{CC} = Min, All Outputs I_{OL} = -16 mA	Com, Ind.			0.5	V

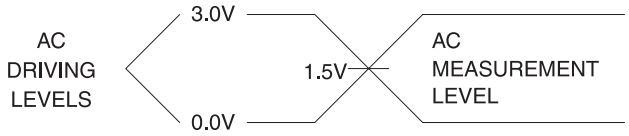
4.1 DC Characteristics

Symbol	Parameter	Condition		Min	Typ	Max	Units
V_{OH}	Output High Voltage	V_{CC} = Min I_{OL} = -3.2 mA		2.4			V
I_{OL}	Output Low Current	V_{CC} = Min	Com.	24			mA
			Ind.	12			
I_{OH}	Output High Current	V_{CC} = Min	Com., Ind.	4			mA

Note: 1. All I_{CC} parameters measured with outputs open. Data is based on Atmel test patterns. Reading may vary with pattern.

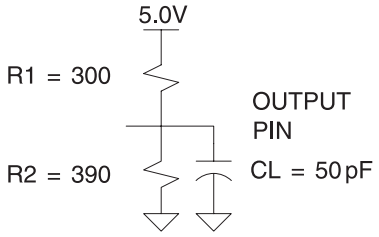
4.4 Input Test Waveforms

4.4.1 Input Test Waveforms and Measurement Levels



t_R, t_F < 1.5 ns (10% to 90%)

4.4.2 Output Test Loads



Note: Similar devices are tested with slightly different loads. These load differences may affect output signals' delay and slew rate. Atmel devices are tested with sufficient margins to meet compatible devices.

4.4.3 Pin Capacitance

Table 4-1. Pin Capacitance (f = 1 MHz, T = 25°C[1])

	Typ	Max	Units	Conditions
C_{IN}	5	8	pF	V_{IN} = 0V
C_{OUT}	6	8	pF	V_{OUT} = 0V

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.

6. Input and I/O Pin-keeper Circuits

The ATF16V8CZ contains internal input and I/O pin-keeper circuits. These circuits allow each ATF16V8CZ pin to hold its previous value even when it is not being driven by an external source or by the device's output buffer. This helps insure that all logic array inputs are at known, valid logic levels. This reduces system power by preventing pins from floating to indeterminate levels. By using pin-keeper circuits rather than pull-up resistors, there is no DC current required to hold the pins in either logic state (high or low).

These pin-keeper circuits are implemented as weak feedback inverters, as shown in the Input Diagram below. These keeper circuits can easily be overdriven by standard TTL- or CMOS-compatible drivers. The typical overdrive current required is 40 µA.

Figure 6-1. Input Diagram

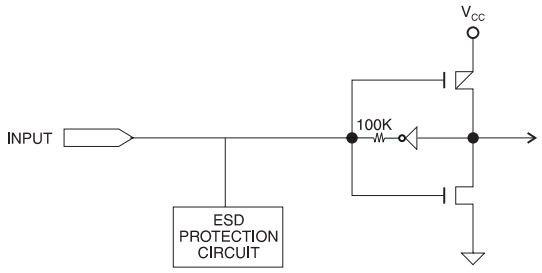
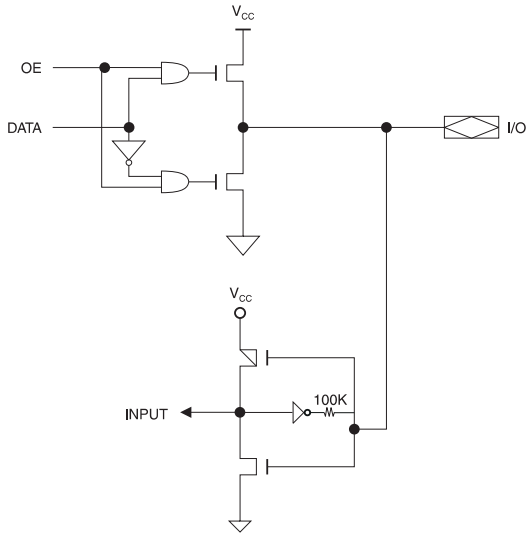


Figure 6-2. I/O Diagram



7. Functional Logic Diagram Description

The Logic Option and Functional Diagrams describe the ATF16V8CZ architecture. Eight configurable macrocells can be configured as a registered output, combinatorial I/O, combinatorial output, or dedicated input.

The ATF16V8CZ can be configured in one of three different modes. Each mode makes the ATF16V8CZ look like a different device. Most PLD compilers can choose the right mode automatically. The user can also force the selection by supplying the compiler with a mode selection. The determining factors would be the usage of register versus combinatorial outputs and dedicated outputs versus outputs with output enable control.

The ATF16V8CZ universal architecture can be programmed to emulate many 20-pin PAL devices. These architectural subsets can be found in each of the configuration modes described in the following pages. The user can download the listed subset device JEDEC programming file to the PLD programmer, and the ATF16V8CZ can be configured to act like the chosen device. Check with your programmer manufacturer for this capability.

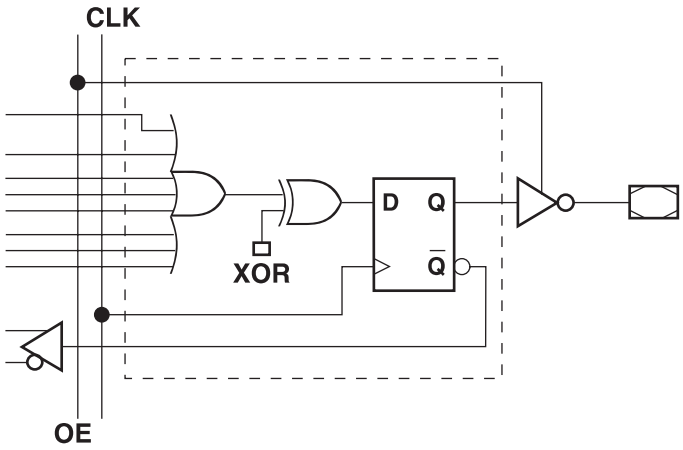
Unused product terms are automatically disabled by the compiler to decrease power consumption. A security fuse, when programmed, protects the content of the ATF16V8CZ. Eight bytes (64 fuses) of User Signature are accessible to the user for purposes such as storing project name, part number, revision, or date. The User Signature is accessible regardless of the state of the security fuse.

Table 7-1. Compiler Mode Selection

	Registered	Complex	Simple	Auto Select
ABEL, Atmel-ABEL	P16C8R	P16V8C	P16V8AS	P16V8
CUPL	G16V8MS	G16V8MA	G16V8AS	G16V8A
LOG/iC	GAL16V8_R(1)	GAL16V8_C7(1)	GAL16V8_C8(1)	GAL16V8
OrCAD-PLD	“Registered”	“Complex”	“Simple”	GAL16V8A
PLDesigner	P16V8R	P16V8C	P16V8C	P16V8A
Tango-PLD	G16V8R	G16V8C	G16V8AS	G16V8

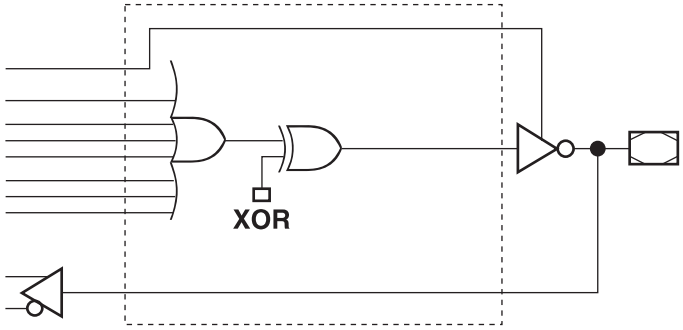
Notes: 1. Only applicable for version 3.4 or lower.

Figure 8-1. Registered Configuration for Registered Mode[1][2]



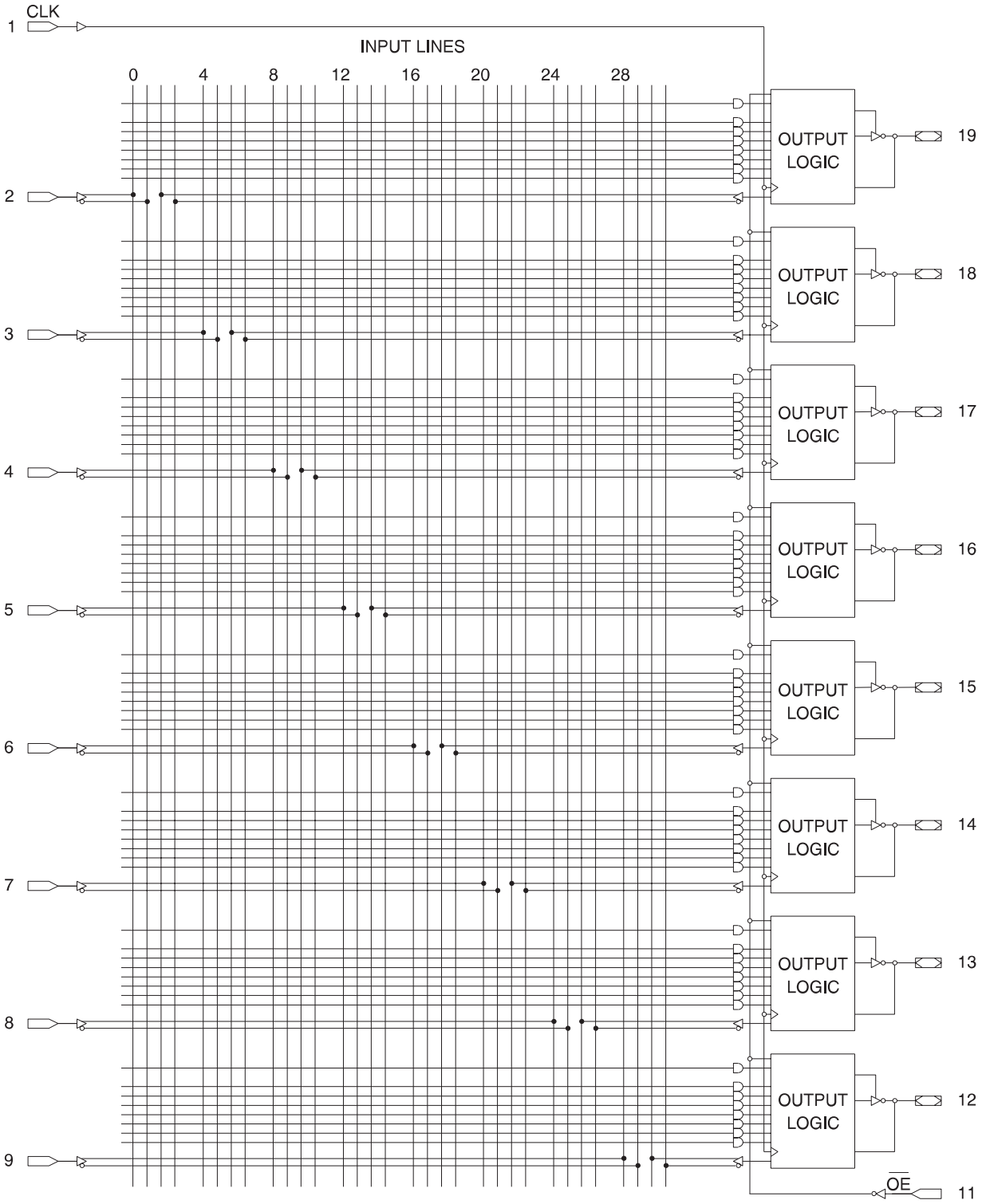
Notes:
1. Pin 1 controls common CLK for the registered outputs.
   Pin 11 controls common $\overline{OE}$ for the registered outputs.
   Pin 1 and Pin 11 are permanently configured as CLK and $\overline{OE}$.
2. The development software configures all the architecture control bits and checks for proper pin usage automatically.

Figure 8-2. Combinatorial Configuration for Registered Mode[1][2]



Notes:
1. Pin 1 and Pin 11 are permanently configured as CLK and $\overline{OE}$.
2. The development software configures all the architecture control bits and checks for proper pin usage automatically.

Figure 8-3. Registered Mode Logic Diagram



8.2 ATF16V8CZ Complex Mode

PAL Device Emulation/PAL Replacement. In the complex mode, combinatorial output and I/O functions are possible. Pins 1 and 11 are regular inputs to the array. Pins 13 through 18 have pin feedback paths back to the AND-array, which makes full I/O capability possible. Pins 12 and 19 (outermost macrocells) are outputs only. They do not have input capability. In this mode, each macrocell has seven product terms going to the sum term and one product term enabling the output.

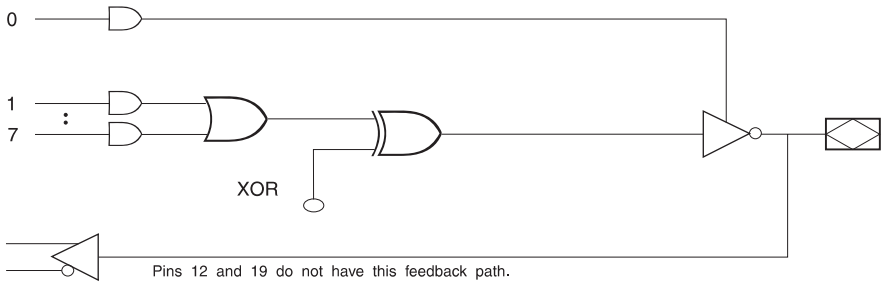
Combinatorial applications with an $\overline{OE}$ requirement will make the compiler select this mode. The following devices can be emulated using this mode:

16L8

16H8

16P8

Figure 8-4. Complex Mode Option



9. ATF16V8CZ Simple Mode

PAL Device Emulation/PAL Replacement. In the Simple Mode, 8 product terms are allocated to the sum term. Pins 15 and 16 (center macrocells) are permanently configured as combinatorial outputs. Other macrocells can be either inputs or combinatorial outputs with pin feedback to the AND-array. Pins 1 and 11 are regular inputs.

The compiler selects this mode when all outputs are combinatorial without $\overline{OE}$ control. The following simple PALs can be emulated using this mode:

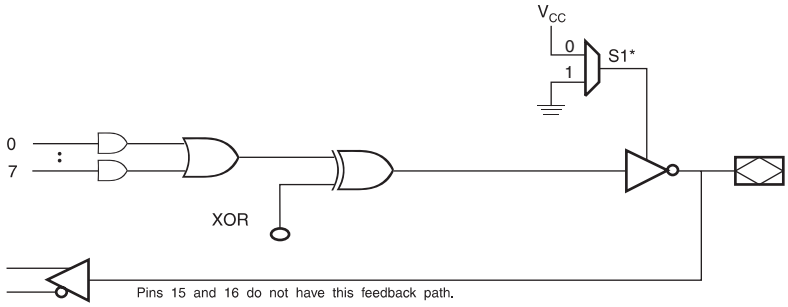
10L8 10H8 10P8

12L6 12H6 12P6

14L4 14H4 14P4

16L2 16H2 16P2

Figure 9-1. Simple Mode Option



* - Pins 15 and 16 are always enabled.

Figure 9-2. Complex Mode Logic Diagram

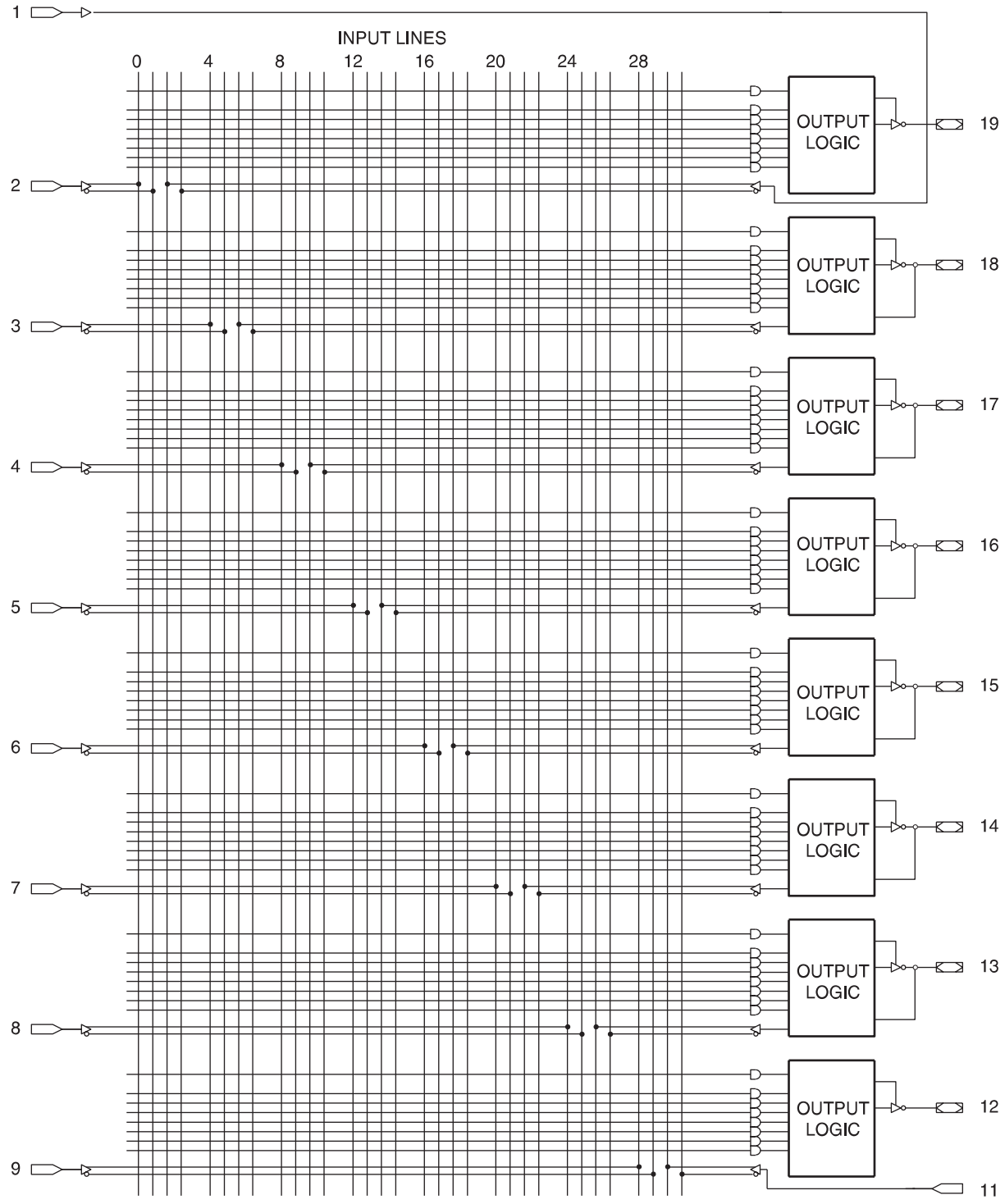
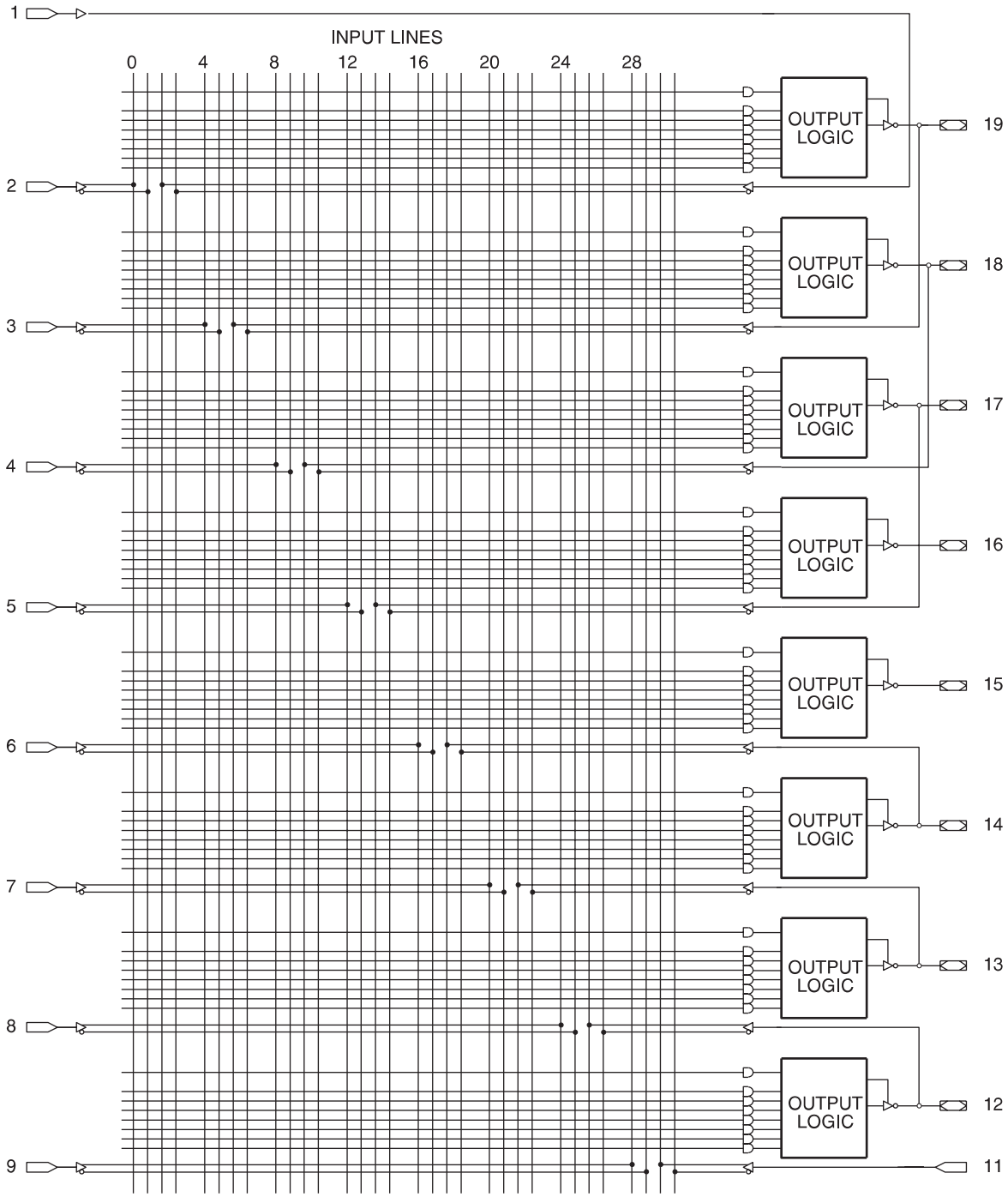
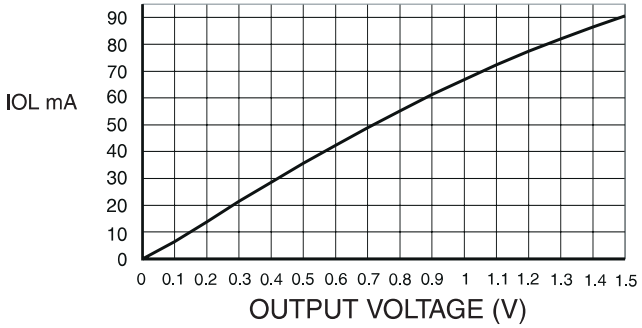


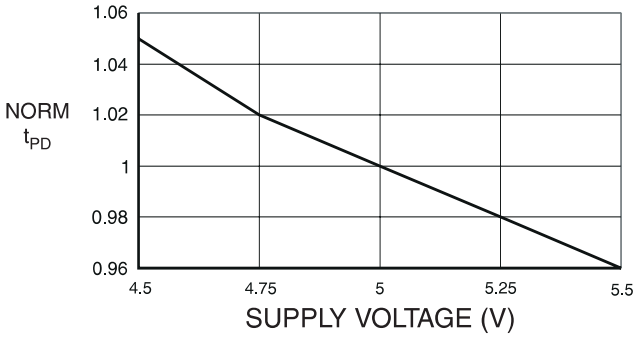
Figure 9-3. Simple Mode Logic Diagram



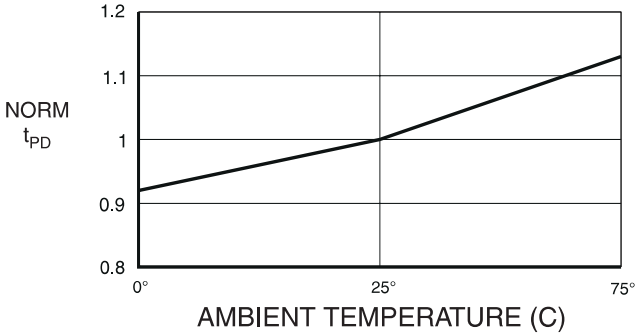
OUTPUT SINK CURRENT
VS. OUTPUT VOLTAGE (VCC = 5V, TA = 25°C)



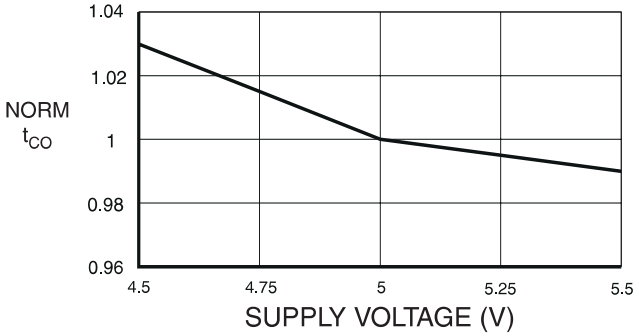
NORMALIZED t_{PD}
VS. SUPPLY VOLTAGE (TA = 25°C)



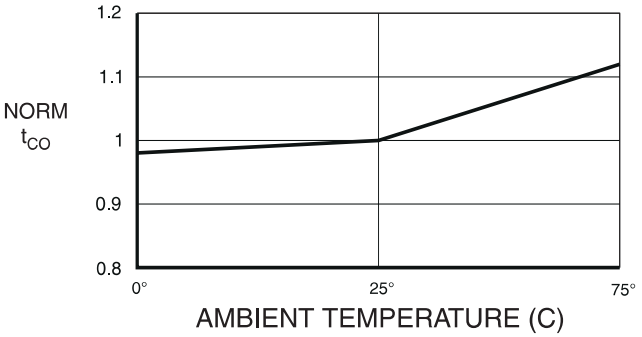
NORMALIZED t_{PD}
VS. AMBIENT TEMPERATURE (TA = 25°C)



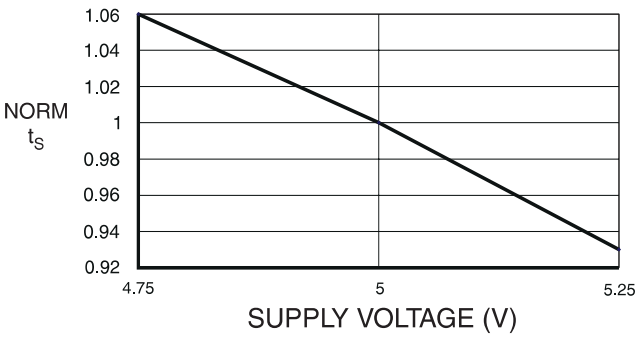
NORMALIZED t_{CO}
VS. SUPPLY VOLTAGE (TA = 25°C)



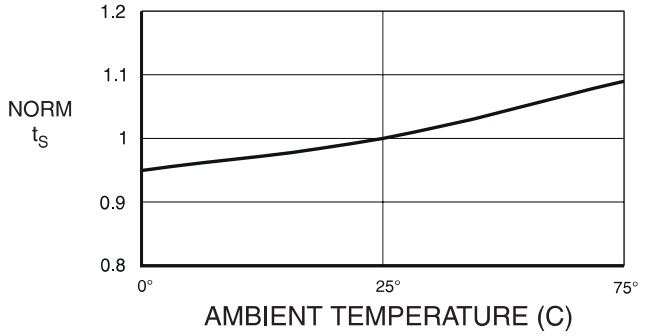
NORMALIZED t_{CO}
VS. AMBIENT TEMPERATURE (VCC = 5V)



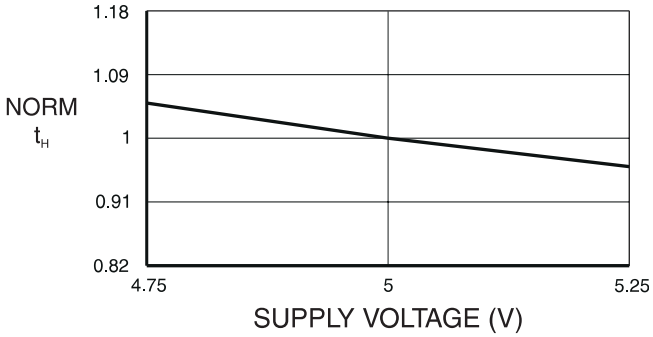
NORMALIZED t_S
VS. SUPPLY VOLTAGE (TA = 25C)



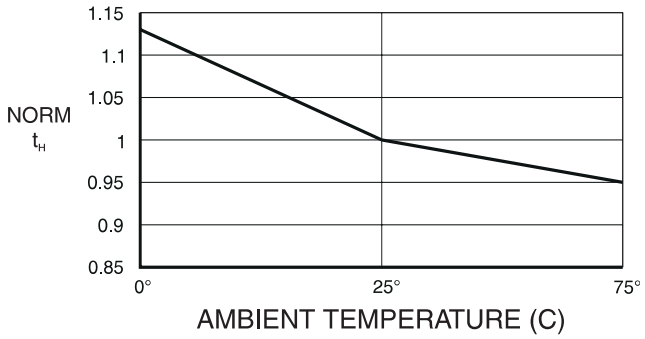
NORMALIZED t_S
VS. AMBIENT TEMPERATURE (TA = 25°C)



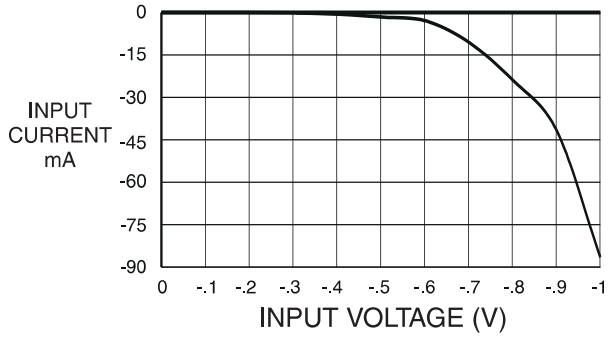
NORMALIZED t_H
VS. SUPPLY VOLTAGE (TA = 25°C)



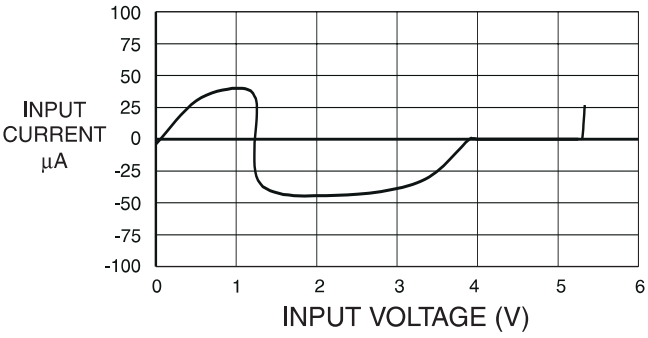
NORMALIZED t_H
VS. AMBIENT TEMPERATURE (VCC = 5V)



INPUT CLAMP CURRENT
VS. INPUT VOLTAGE (TA = 25°C, VCC = 5V)

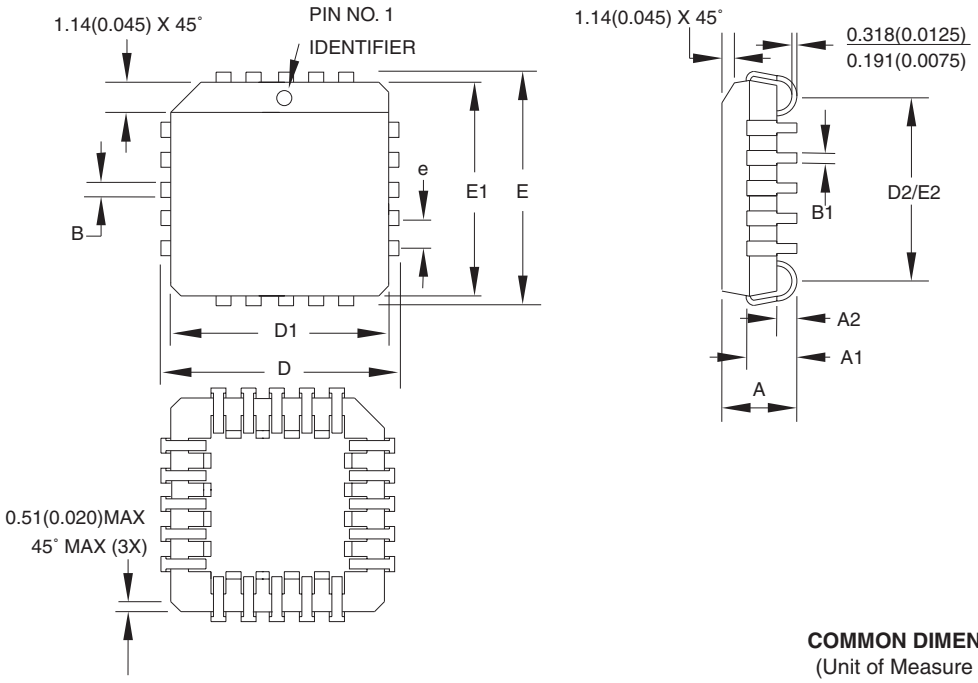


INPUT CURRENT
VS. INPUT VOLTAGE (VCC = 5V, TA = 25°C)



11. Package Information

11.1 20J – PLCC



COMMON DIMENSIONS
(Unit of Measure = mm)

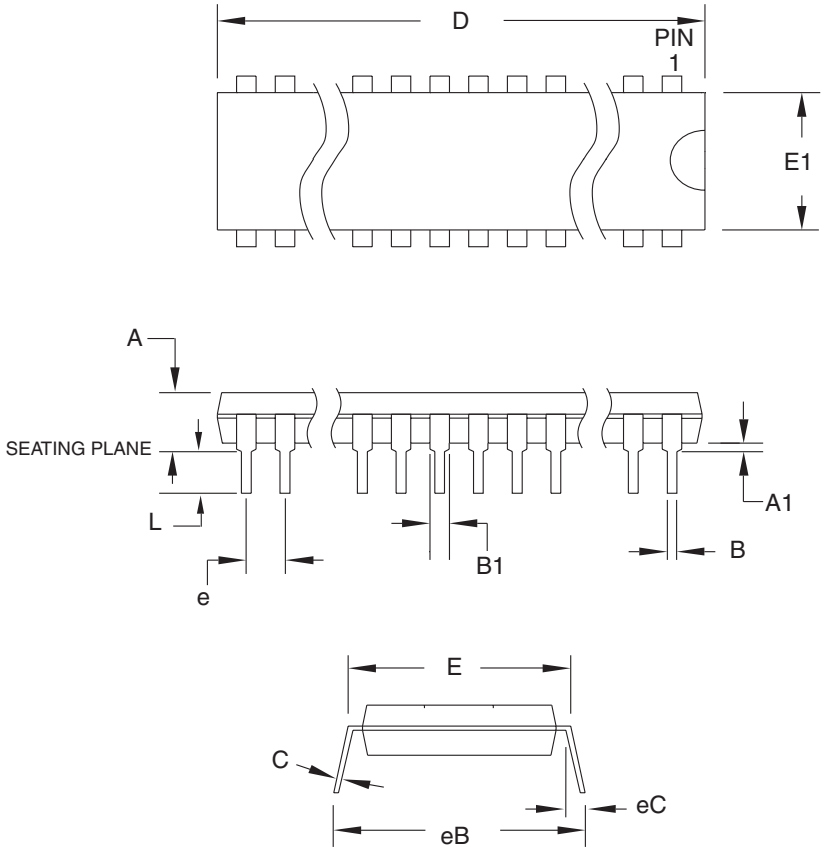
SYMBOL	MIN	NOM	MAX	NOTE
A	4.191	–	4.572	
A1	2.286	–	3.048	
A2	0.508	–	–	
D	9.779	–	10.033	
D1	8.890	–	9.042	Note 2
E	9.779	–	10.033	
E1	8.890	–	9.042	Note 2
D2/E2	7.366	–	8.382	
B	0.660	–	0.813	
B1	0.330	–	0.533	
e	1.270 TYP			

Notes:
1. This package conforms to JEDEC reference MS-018, Variation AA.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010"(0.254 mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
3. Lead coplanarity is 0.004" (0.102 mm) maximum.

10/04/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**20J**, 20-lead, Plastic J-leaded Chip Carrier (PLCC)	20J	B

11.2 20P3 – PDIP



COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	5.334	
A1	0.381	–	–	
D	24.892	–	26.924	Note 2
E	7.620	–	8.255	
E1	6.096	–	7.112	Note 2
B	0.356	–	0.559	
B1	1.270	–	1.551	
L	2.921	–	3.810	
C	0.203	–	0.356	
eB	–	–	10.922	
eC	0.000	–	1.524	
e	2.540 TYP			

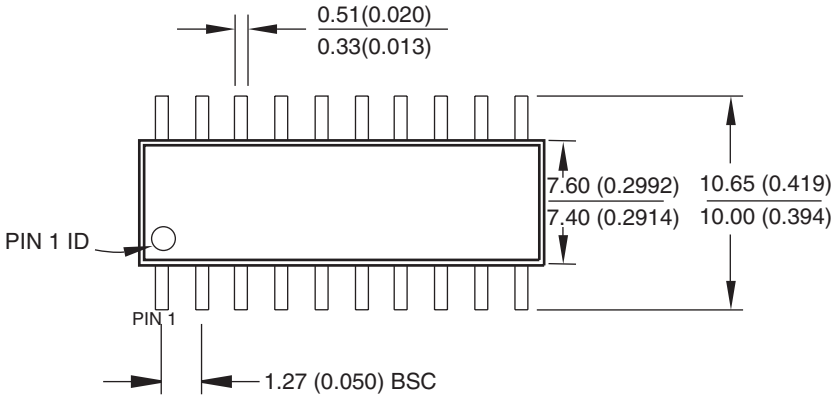
Notes: 1. This package conforms to JEDEC reference MS-001, Variation AD.
2. Dimensions D and E1 do not include mold Flash or Protrusion. Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

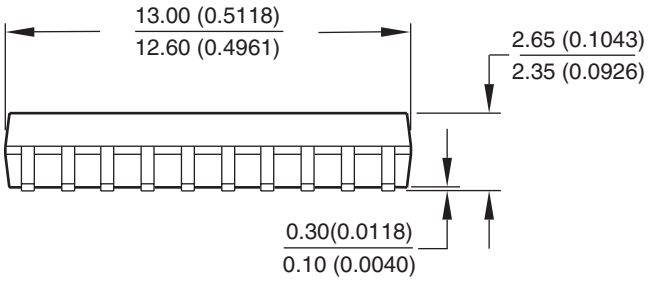
1/23/04

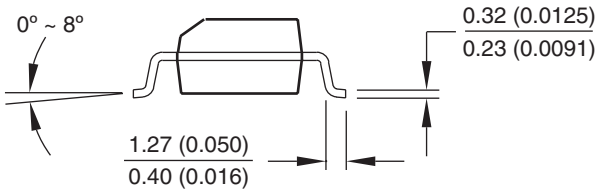
	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**20P3**, 20-lead (0.300"/7.62 mm Wide) Plastic Dual Inline Package (PDIP)	20P3	D

11.3 20S – SOIC

Dimensions in Millimeters and (Inches).
Controlling dimension: Inches.
JEDEC Standard MS-013





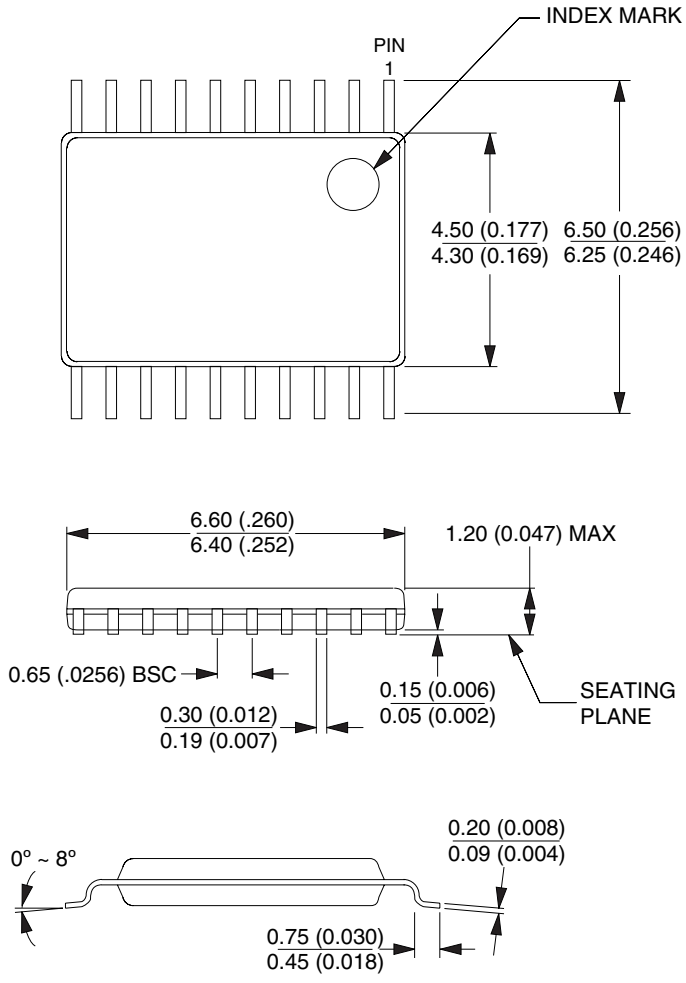


10/23/03

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**20S**, 20-lead, 0.300" Body, Plastic Gull Wing Small Outline (SOIC)	20S	B

11.4 20X – TSSOP

Dimensions in Millimeters and (Inches).
Controlling dimension: Millimeters.
JEDEC Standard MO-153 AC



10/23/03

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**20X**, (Formerly 20T), 20-lead, 4.4 mm Body Width, Plastic Thin Shrink Small Outline Package (TSSOP)	20X	C

12. Revision History

12.1 0453H

1. Green Package options added in 2005.

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